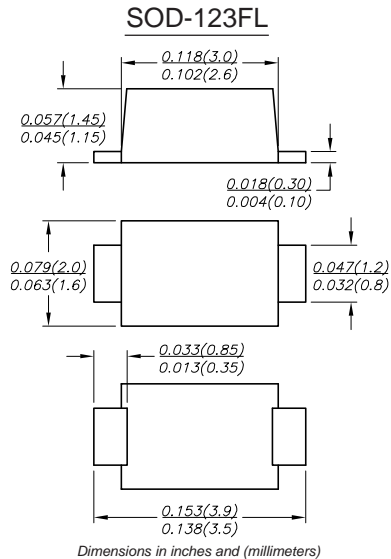


SURFACE MOUNT SUPER FAST RECTIFIER

Reverse Voltage - 50 to 600 Volts Forward Current - 2.0 Ampere



FEATURES

- ◆ Glass passivated device
- ◆ Ideal for surface mouted applications
- ◆ Low reverse leakage
- ◆ Metallurgically bonded construction
- ◆ High temperature soldering guaranteed:
260°C/10 seconds,0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

MECHANICAL DATA

Case:SOD-123FL molded plastic body over passivated chip
Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight:0.0007 ounce, 0.02 grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
 Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

	SYMBOLS	ES2AW	ES2BW	ES2CW	ES2DW	ES2EW	ES2GW	ES2JW	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current	$I_{(AV)}$	2.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	40.0							A
Maximum instantaneous forward voltage at 2.0A	V_F	0.95			1.25		1.7		V
Maximum DC reverse current $T_A=25^{\circ}C$ at rated DC blocking voltage $T_A=100^{\circ}C$	I_R				5.0				μA
Maximum reverse recovery time (NOTE 1)	t_{rr}				35				ns
Typical junction capacitance (NOTE 2)	C_J				10				pF
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$				95				$^{\circ}C/W$
Operating junction and storage temperature range	T_J, T_{STG}				-55 to +150				$^{\circ}C$

- Note:** 1.Measured with $I_F=0.5A$, $I_R=1A$, $I_{rr}=0.25A$.
 2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.
 3.PCB mounted on 0.2*0.2" (5.0*5.0mm) coppeer pad area.

RATINGS AND CHARACTERISTIC CURVES ES2AW THRU ES2JW

FIG. 1- FORWARD CURRENT DERATING CURVE

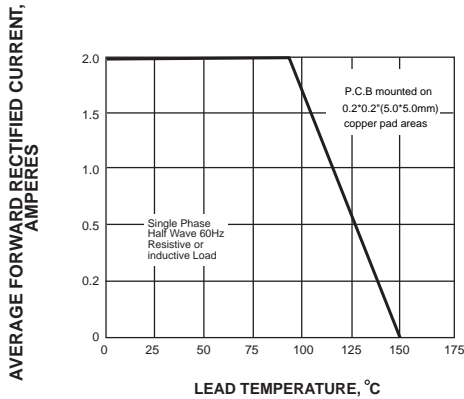


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

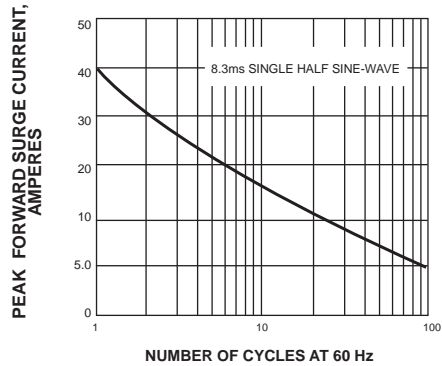


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

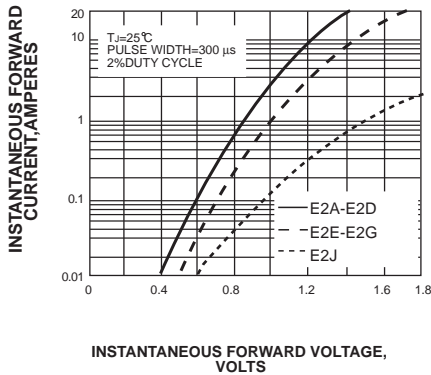


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

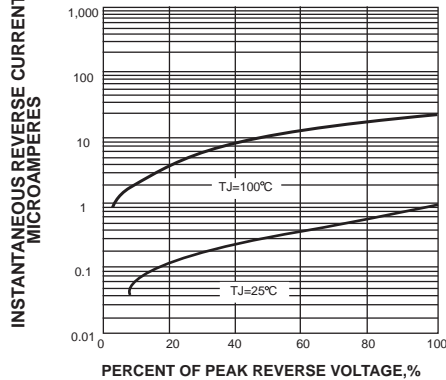


FIG. 5-TYPICAL JUNCTION CAPACITANCE

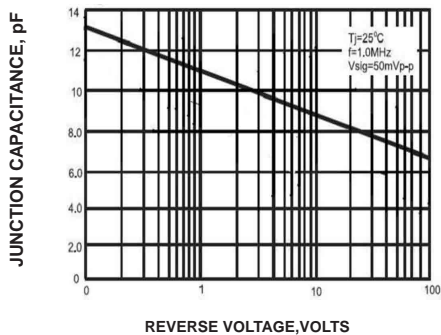


FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE

